



60V P-CHANNEL ENHANCEMENT MODE MOSFET PowerDI5060-8

Product Summary

BV _{DSS}	Rds(on)	I _D Tc = +25°C
-60V	$50m\Omega$ @ $V_{GS} = -10V$	-26A
-00 V	70mΩ @ V _{GS} = -4.5V	-22A

Description and Applications

This new generation 60V P-channel enhancement mode MOSFET is designed to minimize RDS(ON) yet maintain superior switching performance. This device is ideal for use in notebook battery power managements and load switches.

- Notebook battery power managements
- DC-DC converters
- Load switches

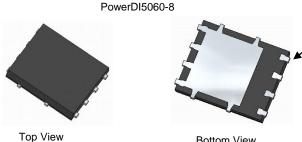
Features and Benefits

- Thermally Efficient Package-Cooler Running Applications
- High Conversion Efficiency
- Low RDS(ON) Minimizes On State Losses
- Low Input Capacitance
- Fast Switching Speed
- <1.1mm Package Profile Ideal for Thin Applications
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/104/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please contact us or your local Diodes representative. https://www.diodes.com/quality/product-definitions/

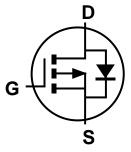
Mechanical Data

- Package: PowerDI®5060-8
- Package Material: Molded Plastic, "Green" Molding Compound; UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminal Finish Matte Tin Annealed over Copper Leadframe; Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.097 grams (Approximate)

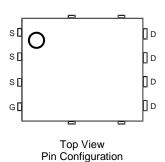
Site 1:





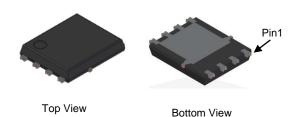


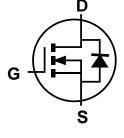
Internal Schematic



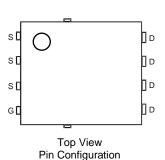
Site 2:

PowerDI5060-8 (SWP) (Type UX)





Internal Schematic





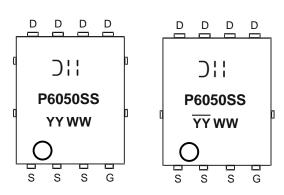
Ordering Information (Note 4)

Part Number	Package	Packing		
Part Number	Package	Qty.	Carrier	
DMP6050SPS-13	PowerDI5060-8	2500	Tape & Reel	
DMP6050SPS-13	PowerDI5060-8 (SWP) (Type UX)	2500	Tape & Reel	

Notes:

- 1. EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant. All applicable RoHS exemptions applied.
 2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



☐ I = Manufacturer's Marking P6050SS = Product Type Marking Code YYWW = Date Code Marking YY or \overline{YY} = Last Two Digits of Year (ex: 22 = 2022) WW = Week Code (01 to 53)

Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic			Symbol	Value	Unit
Drain-Source Voltage			V _{DSS}	-60	V
Gate-Source Voltage			Vgss	±20	V
Continuous Drain Current (Note 6) $V_{GS} = -10V$ Steady $T_A = +25^{\circ}C$ State $T_A = +70^{\circ}C$			lo	-5.7 -4.5	А
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%)			I _{DM}	-45	Α
Maximum Continuous Body Diode Forward Current (Note 6)			Is	-2.4	Α
Pulsed Body Diode Forward Current (10µs Pulse, Duty Cycle = 1%)			I _{SM}	-45	Α
Avalanche Current (Note 8) L = 0.1mH			las	-25	Α
Repetitive Avalanche Energy (Note 8) L = 0.1mH			Eas	32	mJ

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	PD	1.3	W
Thermal Resistance, Junction to Ambient @ T _A = +25°C (Note 5)	R _{0JA}	95	°C/W
Power Dissipation (Note 6)	PD	2.4	W
Thermal Resistance, Junction to Ambient @ T _A = +25°C (Note 6)	Reja	52	°C/W
Thermal Resistance, Junction to Case @ T _C = +25°C (Note 7)	Rejc	2.4	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-55 to +150	°C

Notes:

- 5. Device mounted on FR-4 substrate PC board, 2oz copper, with minimum recommended pad layout.
- 6. Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper plate. 7. Thermal resistance from junction to soldering point (on the exposed drain pad).
- 8. I_{AS} and E_{AS} ratings are based on low frequency and duty cycles to keep T_J = +25°C.



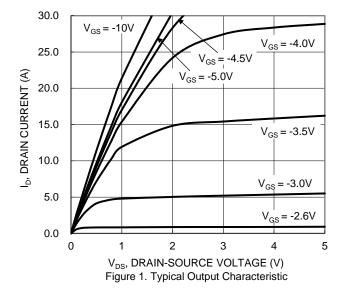
Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 9)		•		•	•		
Drain-Source Breakdown Voltage	BVDSS	-60	_	_	V	$V_{GS} = 0V, I_{D} = -250\mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	-1	μA	V _{DS} = -60V, V _{GS} = 0V	
Gate-Source Leakage	I _{GSS}	_	_	±100	nA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 9)	•						
Gate Threshold Voltage	Vgs(TH)	-1.0	_	-3.0	V	$V_{DS} = V_{GS}$, $I_D = -250\mu A$	
Static Drain-Source On-Resistance	D	_	43	50	mΩ	$V_{GS} = -10V, I_D = -5A$	
Static Dialii-Source Off-Resistance	R _{DS(ON)}	_	53	70	11122	$V_{GS} = -4.5V, I_{D} = -4A$	
Diode Forward Voltage	VsD	_	-0.7	-1.2	V	Vgs = 0V, Is = -1A	
DYNAMIC CHARACTERISTICS (Note 10)	•						
Input Capacitance	Ciss	_	2163	_	pF	V 99V V 9V	
Output Capacitance	Coss	_	88	_	pF	V _{DS} = -30V, V _{GS} = 0V, f = 1.0MHz	
Reverse Transfer Capacitance	Crss	_	58	_	pF	1 - 1.00012	
Gate Resistance	Rg	_	13	_	Ω	$V_{DS} = 0V$, $V_{GS} = 0V$, $f = 1MHz$	
Total Gate Charge (V _{GS} = -10V)	Qg	_	30	_	nC		
Total Gate Charge (V _{GS} = -4.5V)	Qg	_	14	_	nC	\/ 20\/ I- 5A	
Gate-Source Charge	Qgs	_	5	_	nC	$V_{DS} = -30V, I_{D} = -5A$	
Gate-Drain Charge	Qgd	_	4.6	_	nC		
Turn-On Delay Time	t _{D(ON)}	_	4.7	_	ns		
Turn-On Rise Time	t _R	_	2.7	_	ns	$V_{GS} = -10V, V_{DS} = -30V, \\ R_{G} = 3\Omega, I_{D} = -5A$	
Turn-Off Delay Time	tD(OFF)	_	73	_	ns		
Turn-Off Fall Time	tF	_	25	_	ns]	
Body Diode Reverse Recovery Time	t _{RR}	_	18	_	ns	I _F = -5A, di/dt = 100A/μs	
Body Diode Reverse Recovery Charge	Q _{RR}	_	12	_	nC	I _F = -5A, di/dt = 100A/μs	

Notes:

^{9.} Short duration pulse test used to minimize self-heating effect.10. Guaranteed by design. Not subject to product testing.





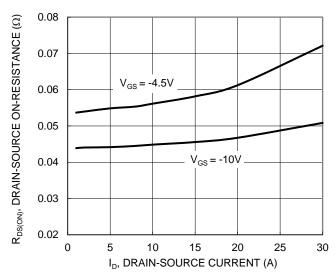


Figure 3. Typical On-Resistance vs. Drain Current and Gate Voltage

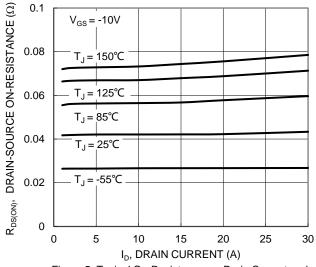
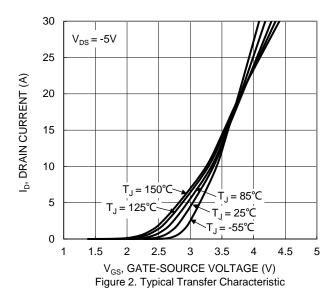


Figure 5. Typical On-Resistance vs. Drain Current and Junction Temperature



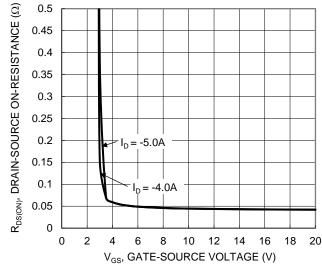


Figure 4. Typical Transfer Characteristic

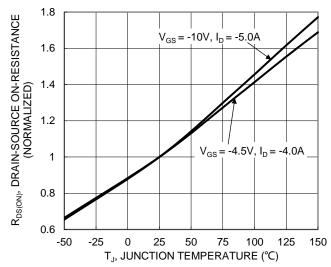


Figure 6. On-Resistance Variation with Junction Temperature



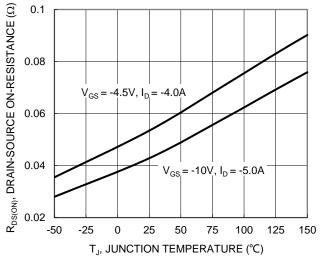
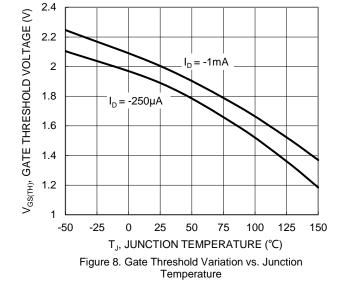


Figure 7. On-Resistance Variation with Junction Temperature



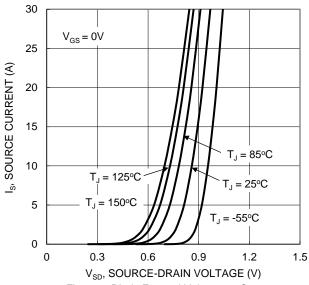
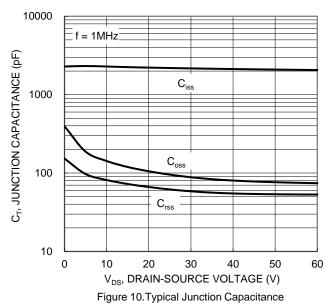


Figure 9. Diode Forward Voltage vs. Current



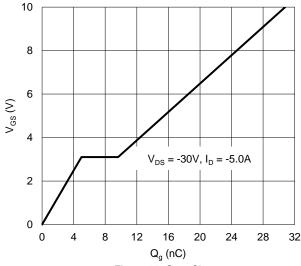


Figure 11. Gate Charge

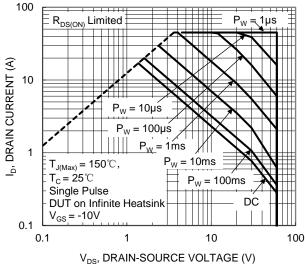


Figure 12. SOA, Safe Operation Area



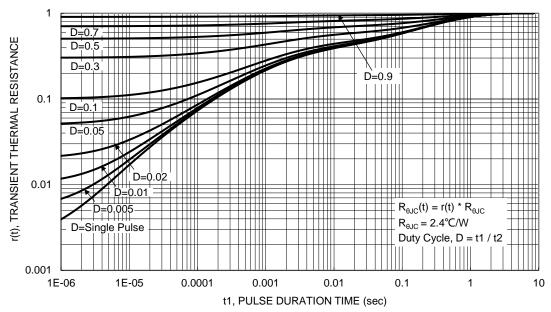


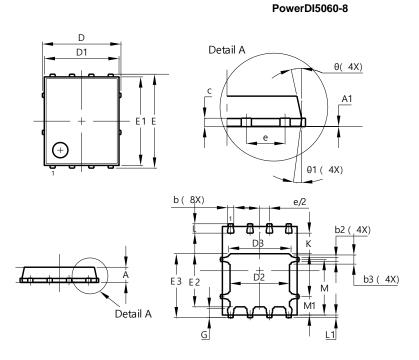
Figure 13. Transient Thermal Resistance



Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

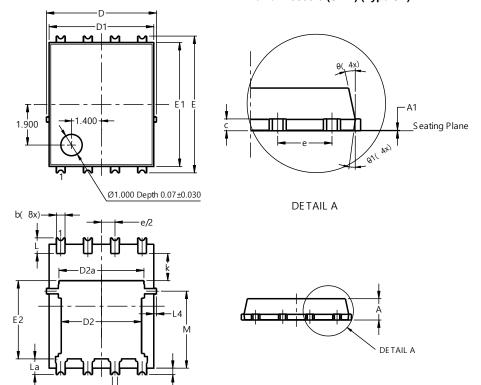
Site1:



PowerDI5060-8			
Dim	Min	Max	Тур
Α	0.90	1.10	1.00
A1	0.00	0.05	-
b	0.33	0.51	0.41
b2	0.200	0.350	0.273
b3	0.40	0.80	0.60
С	0.230	0.330	0.277
D	ļ	5.15 BSC	;
D1	4.70	5.10	4.90
D2	3.70	4.10	3.90
D3	3.90	4.30	4.10
Е	(6.15 BSC	;
E1	5.60	6.00	5.80
E2	3.28	3.68	3.48
E3	3.99	4.39	4.19
е	1.27 BSC		
G	0.51	0.71	0.61
K	0.51	-	-
L	0.51	0.71	0.61
L1	0.100	0.200	0.175
M	3.235	4.035	3.635
M1	1.00	1.40	1.21
Θ	10°	12°	11°
Θ1	6°	8°	7°
All Dimensions in mm			

Site2:

PowerDI5060-8 (SWP) (Type UX)



PowerDI5060-8 (SWP) (Type UX)			
Dim	Min	Max	Тур
Α	0.90	1.10	1.00
A 1	0	0.05	
b	0.30	0.50	0.41
b2	0.20	0.35	0.25
b4	().25REF	=
С	0.230	0.330	0.277
D	5	.15 BS0	2
D1	4.70	5.10	4.90
D2	3.56	3.96	3.76
D2a	3.78	4.18	3.98
Е	6	.40 BS0	\sim
E1	5.60	6.00	5.80
E2	3.46	3.86	3.66
E2a	4.195	4.595	4.395
е	1	.27BSC)
k	1.05		
L	0.635	0.835	0.735
La	0.635	0.835	0.735
L1	0.200	0.400	0.300
L1a	0.050REF		
L4	0.025	0.225	0.125
М	3.205	4.005	3.605
θ	10°	12°	11°
θ1	6°	8°	7°
All Dimensions in mm			

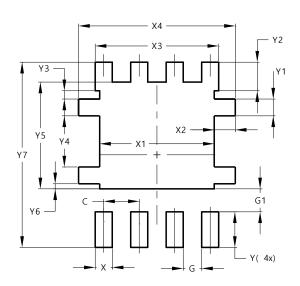


Suggested Pad Layout

 $\label{prop:lease} Please see \ http://www.diodes.com/package-outlines.html for the latest version.$

Site1:

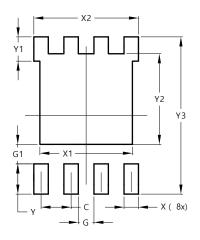
PowerDI5060-8



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
X	0.610
X1	4.100
X2	0.755
Х3	4.420
X4	5.610
Y	1.270
Y1	0.600
Y2	1.020
Y3	0.295
Y4	1.825
Y5	3.810
Y6	0.180
Y7	6.610

Site2:

PowerDI5060-8 (SWP) (Type UX)



Dimensions	Value (in mm)
С	1.270
G	0.660
G1	0.820
Х	0.610
X1	4.100
X2	4.420
Y	1.270
Y1	1.020
Y2	3.810
Y3	6.610



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